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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	F ² MC-16LX
Core Size	16-Bit
Speed	16MHz
Connectivity	CANbus, EBI/EMI, SCI, Serial I/O, UART/USART
Peripherals	POR, WDT
Number of I/O	81
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	6K x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	100-BQFP
Supplier Device Package	100-QFP (14x20)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90f543gspf-gs-9013

3. Pin Description

Pin No.		Pin name	Circuit type	Function
LQFP ²	QFP ¹			
80 81	82 83	X0 X1	A (Oscillation)	High speed crystal oscillator input pins
78	80	X0A	A (Oscillation)	Low speed crystal oscillator input pins. For the one clock system parts, perform external pull-down processing.
77	79	X1A		Low speed crystal oscillator input pins. For the one clock system parts, leave it open.
75	77	$\overline{\text{RST}}$	B	External reset request input pin
50	52	$\overline{\text{HST}}$	C	Hardware standby input pin
83 to 90	85 to 92	P00 to P07	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode.
		AD00 to AD07		I/O pins for 8 lower bits of the external address/data bus. This function is enabled when the external bus is enabled.
91 to 98	93 to 100	P10 to P17	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode.
		AD08 to AD15		I/O pins for 8 higher bits of the external address/data bus. This function is enabled when the external bus is enabled.
99 to 6	1 to 8	P20 to P27	I	General I/O port with programmable pullup. In external bus mode, this function is valid when the corresponding bits in the external address output control resister (HACR) are set to "1".
		A16 to A23		8-bit I/O pins for A16 to A23 at the external address/data bus. In external bus mode, this function is valid when the corresponding bits in the external address output control resister (HACR) are set to "0".
7	9	P30	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode.
		ALE		Address latch enable output pin. This function is enabled when the external bus is enabled.
8	10	P31	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode.
		$\overline{\text{RD}}$		Read strobe output pin for the data bus. This function is enabled when the external bus is enabled.
10	12	P32	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode or when the $\overline{\text{WR}}/\overline{\text{WRL}}$ pin output is disabled.
		$\overline{\text{WRL}}$		Write strobe output pin for the data bus. This function is enabled when both the external bus and the $\overline{\text{WR}}/\overline{\text{WRL}}$ pin output are enabled. $\overline{\text{WRL}}$ is write-strobe output pin for the lower 8 bits of the data bus in 16-bit access.
		$\overline{\text{WR}}$		$\overline{\text{WR}}$ is write-strobe output pin for the 8 bits of the data bus in 8-bit access.

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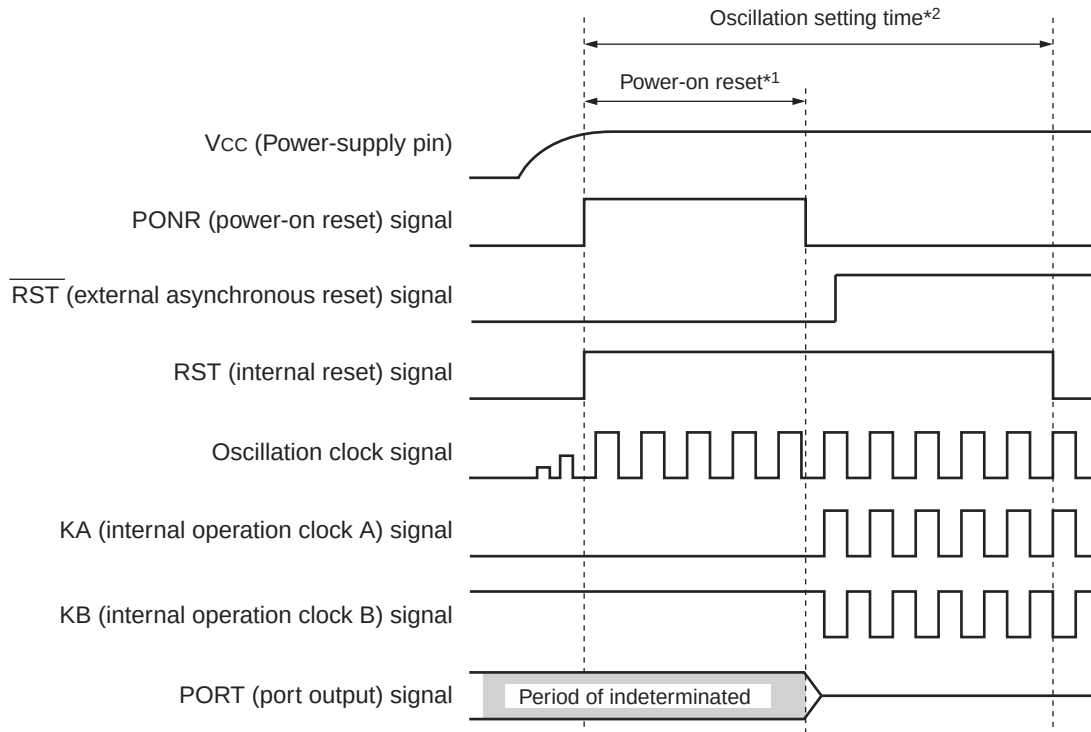
Pin No.		Pin name	Circuit type	Function
LQFP ²	QFP ¹			
20	22	P44	G	General I/O port. This function is enabled when UART1 disables the clock output.
		SCK1		Serial clock pulse I/O pin for UART1. This function is enabled when UART1 enables the serial clock output.
22	24	P45	G	General I/O port. This function is enabled when UART1 disables the serial data output.
		SOT1		Serial data output pin for UART1. This function is enabled when UART1 enables the serial data output.
23	25	P46	G	General I/O port. This function is enabled when the Extended I/O serial interface disables the serial data output.
		SOT2		Serial data output pin for the Extended I/O serial interface. This function is enabled when the Extended I/O serial interface enables the serial data output.
24	26	P47	G	General I/O port. This function is enabled when the Extended I/O serial interface disables the clock output.
		SCK2		Serial clock pulse I/O pin for the Extended I/O serial interface. This function is enabled when the Extended I/O serial interface enables the Serial clock output.
26	28	P50	D	General I/O port. This function is always enabled.
		SIN2		Serial data input pin for the Extended I/O serial interface. Set the corresponding Port Direction Register to input if this function is used.
27 to 30	29 to 32	P51 to P54	D	General I/O port. This function is always enabled.
		INT4 to INT7		External interrupt request input pins for INT4 to INT7. Set the corresponding Port Direction Register to input if this function is used.
31	33	P55	D	General I/O port. This function is always enabled.
		ADTG		Trigger input pin for the A/D converter. Set the corresponding Port Direction Register to input if this function is used.
36 to 39	38 to 41	P60 to P63	E	General I/O port. This function is enabled when the analog input enable register specifies a port.
		AN0 to AN3		Analog input pins for the 8/10-bit A/D converter. This function is enabled when the analog input enable register specifies A/D.
41 to 44	43 to 46	P64 to P67	E	General I/O port. The function is enabled when the analog input enable register specifies a port.
		AN4 to AN7		Analog input pins for the 8/10-bit A/D converter. This function is enabled when the analog input enable register specifies A/D.
45	47	P56	D	General I/O port. This function is always enabled.
		TIN0		Event input pin for the 16-bit reload timers 0. Set the corresponding Port Direction Register to input if this function is used.

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(12) Indeterminate outputs from ports 0 and 1 (MB90V540G only)

During oscillation setting time of step-down circuit (during a power-on reset) after the power is turned on, the outputs from ports 0 and 1 become following state.

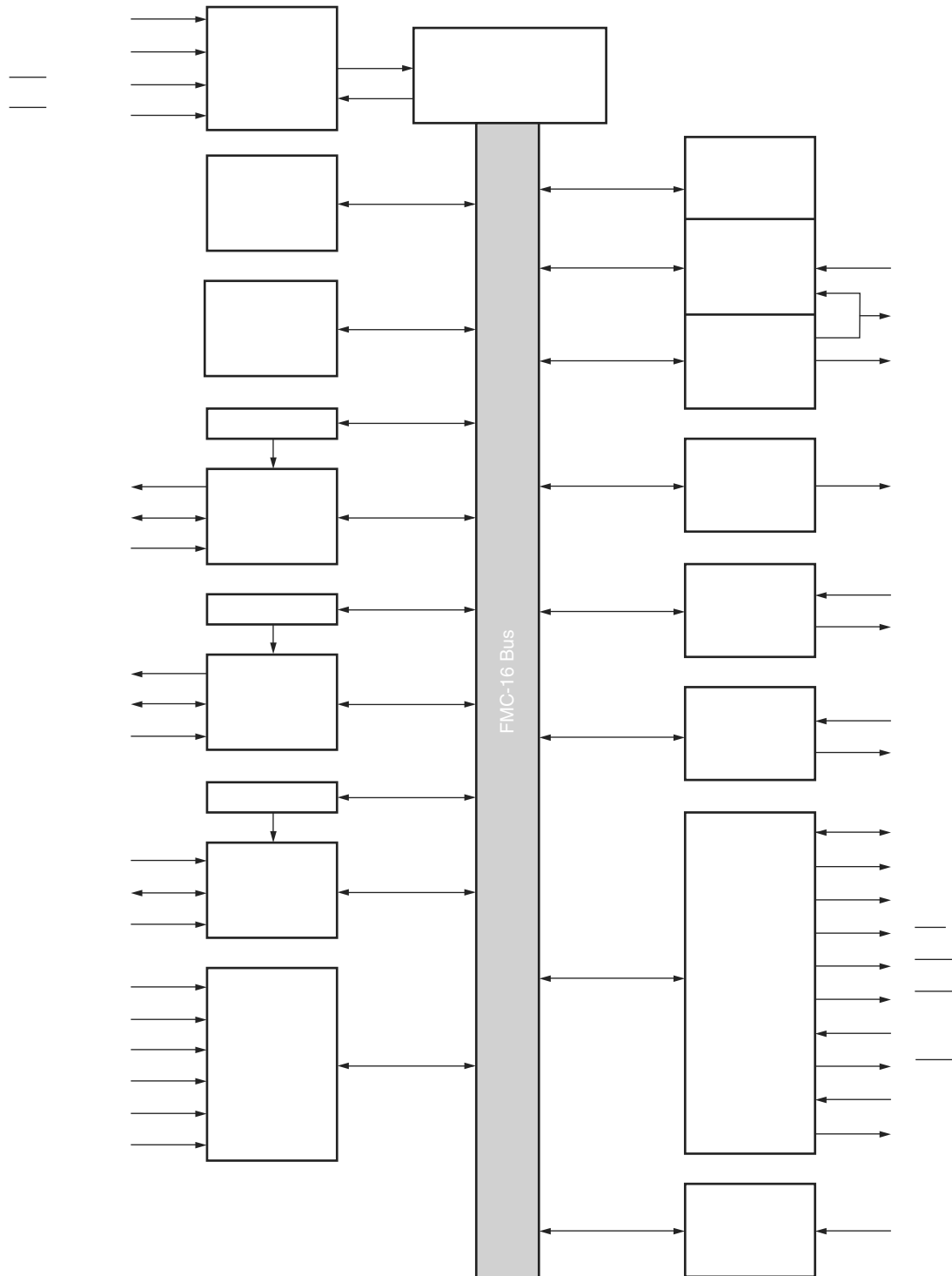
- If $\overline{\text{RST}}$ pin is "H", the outputs become indeterminate.
 - If $\overline{\text{RST}}$ pin is "L", the outputs become high-impedance.
- Pay attention to the port output timing shown as follow.

■ $\overline{\text{RST}}$ pin is "H"


*1 : Power-on reset time : "Period of clock frequency" $\times 2^{17}$ (Clock frequency of 16 MHz : 8.19 ms)

*2 : Oscillation setting time : "Period of clock frequency" $\times 2^{18}$ (Clock frequency of 16 MHz : 16.38 ms)

6. Block Diagram



* : Only the MB90540G series has two channels

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Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
003B00 _H	003D00 _H	Control status register	CSR	R/W, R	00---000 0---0-1 _B
003B01 _H	003D01 _H				
003B02 _H	003D02 _H	Last event indicator register	LEIR	R/W	----- 000-0000 _B
003B03 _H	003D03 _H				
003B04 _H	003D04 _H	Receive/transmit error counter register	RTEC	R	00000000 00000000 _B
003B05 _H	003D05 _H				
003B06 _H	003D06 _H	Bit timing register	BTR	R/W	-1111111 11111111 _B
003B07 _H	003D07 _H				
003B08 _H	003D08 _H	IDE register	IDER	R/W	XXXXXXXX XXXXXXXX _B
003B09 _H	003D09 _H				
003B0A _H	003D0A _H	Transmit RTR register	TRTRR	R/W	00000000 00000000 _B
003B0B _H	003D0B _H				
003B0C _H	003D0C _H	Remote frame receive waiting register	RFWTR	R/W	XXXXXXXX XXXXXXXX _B
003B0D _H	003D0D _H				
003B0E _H	003D0E _H	Transmit request enable register	TIER	R/W	00000000 00000000 _B
003B0F _H	003D0F _H				
003B10 _H	003D10 _H	Acceptance mask select register	AMSR	R/W	XXXXXXXX XXXXXXXX _B
003B11 _H	003D11 _H				XXXXXXXX XXXXXXXX _B
003B12 _H	003D12 _H				
003B13 _H	003D13 _H				
003B14 _H	003D14 _H	Acceptance mask register 0	AMR0	R/W	XXXXXXXX XXXXXXXX _B
003B15 _H	003D15 _H				XXXXXX--- XXXXXXXX _B
003B16 _H	003D16 _H				
003B17 _H	003D17 _H				
003B18 _H	003D18 _H	Acceptance mask register 1	AMR1	R/W	XXXXXXXX XXXXXXXX _B
003B19 _H	003D19 _H				XXXXXX--- XXXXXXXX _B
003B1A _H	003D1A _H				
003B1B _H	003D1B _H				

List of Message Buffers (ID Registers)

Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
003A00 _H to 003A1F _H	003C00 _H to 003C1F _H	General-purpose RAM	—	R/W	XXXXXXXX _B to XXXXXXXX _B
003A20 _H	003C20 _H	ID register 0	IDR0	R/W	XXXXXXXX XXXXXXXX _B
003A21 _H	003C21 _H				XXXXXX--- XXXXXXXX _B
003A22 _H	003C22 _H				
003A23 _H	003C23 _H				

Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
003A24 _H	003C24 _H	ID register 1	IDR1	R/W	XXXXXXXX XXXXXXXX _B
003A25 _H	003C25 _H				
003A26 _H	003C26 _H				XXXXXX--- XXXXXXXX _B
003A27 _H	003C27 _H				
003A28 _H	003C28 _H	ID register 2	IDR2	R/W	XXXXXXXX XXXXXXXX _B
003A29 _H	003C29 _H				
003A2A _H	003C2A _H				XXXXXX--- XXXXXXXX _B
003A2B _H	003C2B _H				
003A2C _H	003C2C _H	ID register 3	IDR3	R/W	XXXXXXXX XXXXXXXX _B
003A2D _H	003C2D _H				
003A2E _H	003C2E _H				XXXXXX--- XXXXXXXX _B
003A2F _H	003C2F _H				
003A30 _H	003C30 _H	ID register 4	IDR4	R/W	XXXXXXXX XXXXXXXX _B
003A31 _H	003C31 _H				
003A32 _H	003C32 _H				XXXXXX--- XXXXXXXX _B
003A33 _H	003C33 _H				
003A34 _H	003C34 _H	ID register 5	IDR5	R/W	XXXXXXXX XXXXXXXX _B
003A35 _H	003C35 _H				
003A36 _H	003C36 _H				XXXXXX--- XXXXXXXX _B
003A37 _H	003C37 _H				
003A38 _H	003C38 _H	ID register 6	IDR6	R/W	XXXXXXXX XXXXXXXX _B
003A39 _H	003C39 _H				
003A3A _H	003C3A _H				XXXXXX--- XXXXXXXX _B
003A3B _H	003C3B _H				

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Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
003A3C _H	003C3C _H	ID register 7	IDR7	R/W	XXXXXXXX XXXXXXXX _B
003A3D _H	003C3D _H				
003A3E _H	003C3E _H				XXXXX--- XXXXXXXX _B
003A3F _H	003C3F _H				
003A40 _H	003C40 _H	ID register 8	IDR8	R/W	XXXXXXXX XXXXXXXX _B
003A41 _H	003C41 _H				
003A42 _H	003C42 _H				XXXXX--- XXXXXXXX _B
003A43 _H	003C43 _H				
003A44 _H	003C44 _H	ID register 9	IDR9	R/W	XXXXXXXX XXXXXXXX _B
003A45 _H	003C45 _H				
003A46 _H	003C46 _H				XXXXX--- XXXXXXXX _B
003A47 _H	003C47 _H				
003A48 _H	003C48 _H	ID register 10	IDR10	R/W	XXXXXXXX XXXXXXXX _B
003A49 _H	003C49 _H				
003A4A _H	003C4A _H				XXXXX--- XXXXXXXX _B
003A4B _H	003C4B _H				
003A4C _H	003C4C _H	ID register 11	IDR11	R/W	XXXXXXXX XXXXXXXX _B
003A4D _H	003C4D _H				
003A4E _H	003C4E _H				XXXXX--- XXXXXXXX _B
003A4F _H	003C4F _H				
003A50 _H	003C50 _H	ID register 12	IDR12	R/W	XXXXXXXX XXXXXXXX _B
003A51 _H	003C51 _H				
003A52 _H	003C52 _H				XXXXX--- XXXXXXXX _B
003A53 _H	003C53 _H				
003A54 _H	003C54 _H	ID register 13	IDR13	R/W	XXXXXXXX XXXXXXXX _B
003A55 _H	003C55 _H				
003A56 _H	003C56 _H				XXXXX--- XXXXXXXX _B
003A57 _H	003C57 _H				
003A58 _H	003C58 _H	ID register 14	IDR14	R/W	XXXXXXXX XXXXXXXX _B
003A59 _H	003C59 _H				
003A5A _H	003C5A _H				XXXXX--- XXXXXXXX _B
003A5B _H	003C5B _H				
003A5C _H	003C5C _H	ID register 15	IDR15	R/W	XXXXXXXX XXXXXXXX _B
003A5D _H	003C5D _H				
003A5E _H	003C5E _H				XXXXX--- XXXXXXXX _B
003A5F _H	003C5F _H				

10. Interrupt Map

Interrupt cause	EI ² OS clear	Interrupt vector		Interrupt control register	
		Number	Address	Number	Address
Reset	N/A	#08	FFFFDC _H	—	—
INT9 instruction	N/A	#09	FFFFD8 _H	—	—
Exception	N/A	#10	FFFFD4 _H	—	—
CAN 0 RX	N/A	#11	FFFFD0 _H	ICR00	0000B0 _H
CAN 0 TX/NS	N/A	#12	FFFFCC _H		
CAN 1 RX	N/A	#13	FFFFC8 _H	ICR01	0000B1 _H
CAN 1 TX/NS	N/A	#14	FFFFC4 _H		
External Interrupt INT0/INT1	*1	#15	FFFFC0 _H	ICR02	0000B2 _H
Time Base Timer	N/A	#16	FFFFBC _H		
16-bit Reload Timer 0	*1	#17	FFFFB8 _H	ICR03	0000B3 _H
8/10-bit A/D Converter	*1	#18	FFFFB4 _H		
16-bit Free-run Timer	N/A	#19	FFFFB0 _H	ICR04	0000B4 _H
External Interrupt INT2/INT3	*1	#20	FFFFAC _H		
Serial I/O	*1	#21	FFFFA8 _H	ICR05	0000B5 _H
8/16-bit PPG 0/1	N/A	#22	FFFFA4 _H		
Input Capture 0	*1	#23	FFFFA0 _H	ICR06	0000B6 _H
External Interrupt INT4/INT5	*1	#24	FFFF9C _H		
Input Capture 1	*1	#25	FFFF98 _H	ICR07	0000B7 _H
8/16-bit PPG 2/3	N/A	#26	FFFF94 _H		
External Interrupt INT6/INT7	*1	#27	FFFF90 _H	ICR08	0000B8 _H
Watch Timer	N/A	#28	FFFF8C _H		
8/16-bit PPG 4/5	N/A	#29	FFFF88 _H	ICR09	0000B9 _H
Input Capture 2/3	*1	#30	FFFF84 _H		
8/16-bit PPG 6/7	N/A	#31	FFFF80 _H	ICR10	0000BA _H
Output Compare 0	*1	#32	FFFF7C _H		
Output Compare 1	*1	#33	FFFF78 _H	ICR11	0000BB _H
Input Capture 4/5	*1	#34	FFFF74 _H		
Output Compare 2/3 - Input Capture 6/7	*1	#35	FFFF70 _H	ICR12	0000BC _H
16-bit Reload Timer 1	*1	#36	FFFF6C _H		
UART 0 RX	*2	#37	FFFF68 _H	ICR13	0000BD _H
UART 0 TX	*1	#38	FFFF64 _H		
UART 1 RX	*2	#39	FFFF60 _H	ICR14	0000BE _H
UART 1 TX	*1	#40	FFFF5C _H		
Flash Memory	N/A	#41	FFFF58 _H	ICR15	0000BF _H
Delayed interrupt	N/A	#42	FFFF54 _H		

(Continued)

11. Electrical Characteristics

11.1 Absolute Maximum Ratings

($V_{SS} = AV_{SS} = 0.0\text{ V}$)

Parameter	Symbol	Value		Units	Remarks
		Min	Max		
Power supply voltage	V_{CC}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	
	AV_{CC}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	$V_{CC} = AV_{CC}$ *1
	$AVRH, AVRL$	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	$AV_{CC} \geq AVRH/AVRL, AVRH \geq AVRL$ *1
Input voltage	V_I	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	*2
Output voltage	V_O	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	*2
Maximum clamp current	I_{CLAMP}	- 2.0	+ 2.0	mA	*6
Total maximum clamp current	$\Sigma I_{CLAMP} $	—	20	mA	*6
"L" level max output current	I_{OL}	—	15	mA	*3
"L" level avg. output current	I_{OLAV}	—	4	mA	*4
"L" level max overall output current	ΣI_{OL}	—	100	mA	
"L" level avg. overall output current	ΣI_{OLAV}	—	50	mA	*5
"H" level max output current	I_{OH}	—	-15	mA	*3
"H" level avg. output current	I_{OHAV}	—	-4	mA	*4
"H" level max overall output current	ΣI_{OH}	—	-100	mA	
"H" level avg. overall output current	ΣI_{OHAV}	—	-50	mA	*5
Power consumption	P_D	—	500	mW	Flash device
		—	400	mW	MASK ROM
Operating temperature	T_A	-40	+105	°C	
Storage temperature	T_{STG}	-55	+150	°C	

*1 : AV_{CC} , $AVRH$, $AVRL$ should not exceed V_{CC} . Also, $AVRH$, $AVRL$ should not exceed AV_{CC} , and $AVRL$ does not exceed $AVRH$.

*2 : V_I and V_O should not exceed $V_{CC} + 0.3\text{ V}$. However if the maximum current to/from an input is limited by some means with external components, the I_{CLAMP} rating supercedes the V_I rating.

*3 : The maximum output current is a peak value for a corresponding pin.

*4 : Average output current is an average current value observed for a 100 ms period for a corresponding pin.

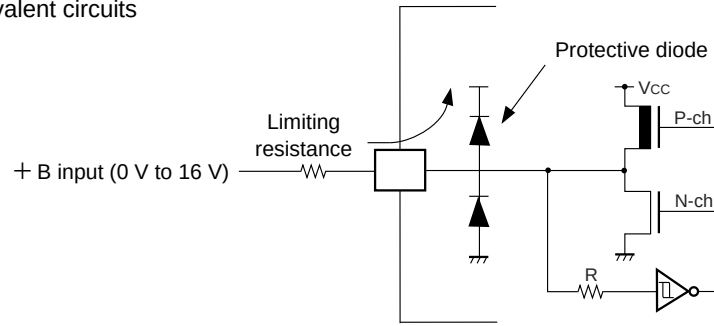
*5 : Total average current is an average current value observed for a 100 ms period for all corresponding pins.

*6 :

- Applicable to pins : P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, PA0
- Use within recommended operating conditions.
- Use at DC voltage (current) .
- The + B signal should always be applied with a limiting resistance placed between the + B signal and the microcontroller.
- The value of the limiting resistance should be set so that when the + B signal is applied the input current to the microcontroller pin does not exceed rated values, either instantaneously or for prolonged periods.
- Note that when the microcontroller drive current is low, such as in the power saving modes, the + B input potential may pass through the protective diode and increase the potential at the V_{CC} pin, and this may affect other devices.
- Note that if a + B signal is input when the microcontroller current is off (not fixed at 0 V) , the power supply is provided from the pins, so that incomplete operation may result.
- Note that if the + B input is applied during power-on, the power supply is provided from the pins and the resulting supply voltage may not be sufficient to operate the power-on result.
- Care must be taken not to leave the + B input pin open.

- ❑ Note that analog system input/output pins other than the A/D input pins (LCD drive pins, comparator input pins, etc.) cannot accept + B signal input.
- ❑ Sample recommended circuits :

■ Input/Output Equivalent circuits



WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

11.2 Recommended Conditions

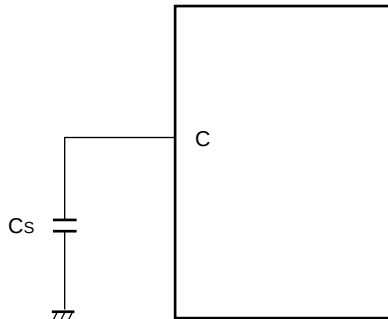
($V_{SS} = AV_{SS} = 0.0\text{ V}$)

Parameter	Symbol	Value			Units	Remarks
		Min	Typ	Max		
Power supply voltage	V_{CC}, AV_{CC}	4.5	5.0	5.5	V	Under normal operation : Other than MB90F548GL(S)/543G(S)/547G(S)/548G(S)
						Under normal operation when A/D converter is used : MB90F548GL(S)/543G(S)/547G(S)/548G(S)
		3.5	5.0	5.5	V	Under normal operation when A/D converter is not used : MB90F548GL(S)/543G(S)/547G(S)/548G(S)
		3.0	—	5.5	V	Maintain RAM data in stop mode
Smooth capacitor	C_S	0.022	0.1	1.0	μF	*
Operating temperature	T_A	−40	—	+105	°C	

*: Use a ceramic capacitor or a capacitor of better 4. AC characteristics. The bypass capacitor should be greater than this capacitor.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges. Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure. No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

■ C Pin Connection Diagram



11.3 DC Characteristics

(MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 3.5 \text{ V to } 5.5 \text{ V}$, $V_{SS} = AV_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^{\circ}\text{C to } +105 \text{ }^{\circ}\text{C}$)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^{\circ}\text{C to } +105 \text{ }^{\circ}\text{C}$)

Parameter	Symbol	Pin name	Condition	Value			Units	Remarks
				Min	Typ	Max		
Input H voltage	V_{IHS}	CMOS hysteresis input pin	—	$0.8 V_{CC}$	—	$V_{CC} + 0.3$	V	
	V_{IH}	TTL input pin	—	2.0	—	—	V	
	V_{IHM}	MD input pin	—	$V_{CC} - 0.3$	—	$V_{CC} + 0.3$	V	
Input L voltage	V_{ILS}	CMOS hysteresis input pin	—	$V_{CC} - 0.3$	—	$0.2 V_{CC}$	V	
	V_{IL}	TTL input pin	—	—	—	0.8	V	
	V_{ILM}	MD input pin	—	$V_{SS} - 0.3$	—	$V_{SS} + 0.3$	V	
Output H voltage	V_{OH}	All output pins	$V_{CC} = 4.5 \text{ V}$, $I_{OH} = -4.0 \text{ mA}$	$V_{CC} - 0.5$	—	—	V	
Output L voltage	V_{OL}	All output pins	$V_{CC} = 4.5 \text{ V}$, $I_{OL} = 4.0 \text{ mA}$	—	—	0.4	V	
Input leak current	I_{IL}	—	$V_{CC} = 5.5 \text{ V}$, $V_{SS} < V_I < V_{CC}$	—5	—	5	μA	
Pull-up resistance	R_{UP}	P00 to P07, P10 to P17, P20 to P27, P30 to P37, RST	—	25	50	100	$\text{k}\Omega$	
Pull-down resistance	R_{DOWN}	MD2	—	25	50	100	$\text{k}\Omega$	Except Flash devices

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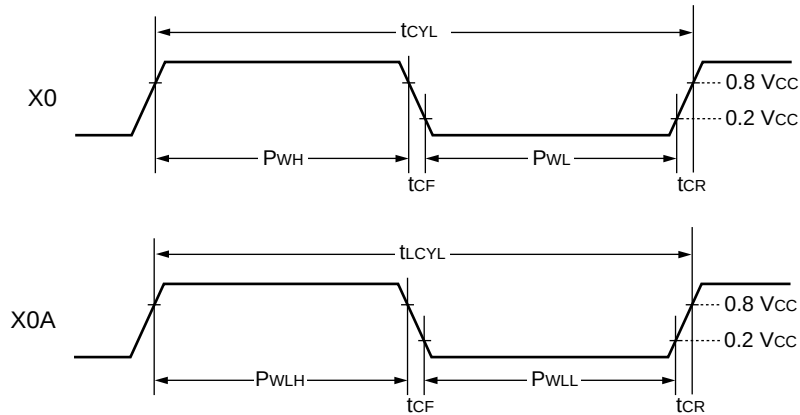
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(MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 3.5\text{ V to }5.5\text{ V}$, $V_{SS} = AV_{SS} = 0.0\text{ V}$, $T_A = -40\text{ °C to }+105\text{ °C}$)

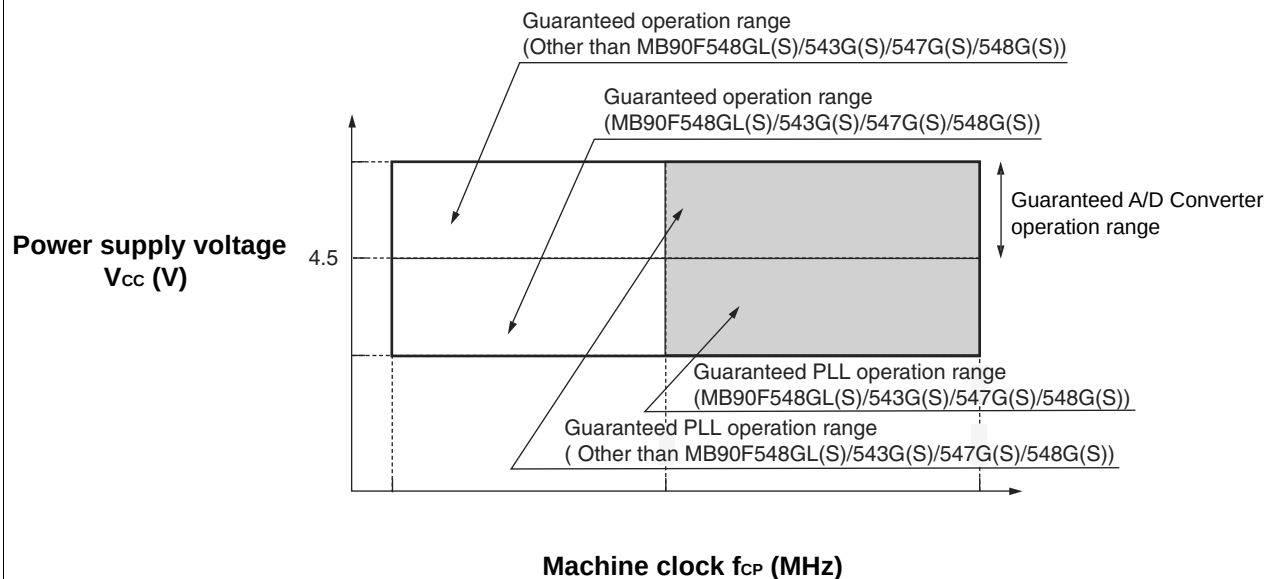
(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0.0\text{ V}$, $T_A = -40\text{ °C to }+105\text{ °C}$)

Parameter	Symbol	Pin name	Value			Units	Remarks
			Min	Typ	Max		
Clock cycle time	t_{CYL}	X0, X1	62.5	—	333	ns	No multiplier When using an oscillator circuit $V_{CC} = 5.0\text{ V} \pm 10\%$
			62.5	—	125	ns	PLL multiplied by 1 When using an oscillator circuit $V_{CC} = 5.0\text{ V} \pm 10\%$
			125	—	250	ns	PLL multiplied by 2 When using an oscillator circuit $V_{CC} = 5.0\text{ V} \pm 10\%$
			187.5	—	333	ns	PLL multiplied by 3 When using an oscillator circuit $V_{CC} = 5.0\text{ V} \pm 10\%$
			250	—	333	ns	PLL multiplied by 4 When using an oscillator circuit $V_{CC} = 5.0\text{ V} \pm 10\%$
			200	—	333	ns	When using an oscillator circuit $V_{CC} < 4.5\text{ V}$ (MB90F548GL(S)/543G(S)/ 547G(S)/548G(S))
			62.5	—	333	ns	No multiplier When using an external clock
			62.5	—	125	ns	PLL multiplied by 1 When using an external clock
			125	—	250	ns	PLL multiplied by 2 When using an external clock
			187.5	—	333	ns	PLL multiplied by 3 When using an external clock
			250	—	333	ns	PLL multiplied by 4 When using an external clock
	t_{LCYL}	X0A, X1A	—	30.5	—	μs	
Input clock pulse width	P_{WH}, P_{WL}	X0	10	—	—	ns	Duty ratio is about 30% to 70%.
	P_{WLH}, P_{WLL}	X0A	—	15.2	—	μs	
Input clock rise and fall time	t_{CR}, t_{CF}	X0	—	—	5	ns	When using an external clock
Machine clock frequency	f_{CP}	—	1.5	—	16	MHz	When using main clock
	f_{LCP}	—	—	8.192	—	kHz	When using sub-clock
Machine clock cycle time	t_{CP}	—	62.5	—	666	ns	When using main clock
	t_{LCP}	—	—	122.1	—	μs	When using sub-clock

■ Clock Timing



■ Guaranteed PLL operation range

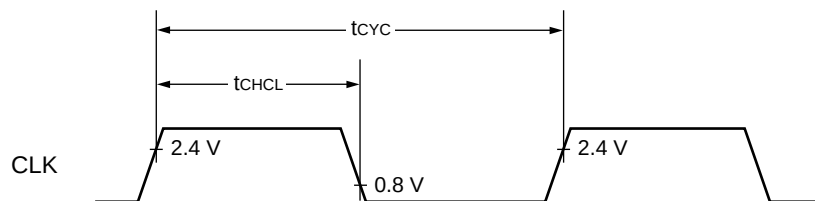


11.4.2 Clock Output Timing

(MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 3.5\text{ V to }5.5\text{ V}$, $V_{SS} = AV_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^{\circ}\text{C to }+105\text{ }^{\circ}\text{C}$)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^{\circ}\text{C to }+105\text{ }^{\circ}\text{C}$)

Parameter	Symbol	Pin name	Condition	Value		Units	Remarks
				Min	Max		
Cycle time	t_{CYC}	CLK	$V_{CC} = 5\text{ V} \pm 10\%$	62.5	—	ns	
CLK $\uparrow$ → CLK $\downarrow$	t_{CHCL}			20	—	ns	



11.4.3 Reset and Hardware Standby Input Timing

(MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 3.5\text{ V to }5.5\text{ V}$, $V_{SS} = AV_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^{\circ}\text{C to }+105\text{ }^{\circ}\text{C}$)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^{\circ}\text{C to }+105\text{ }^{\circ}\text{C}$)

Parameter	Symbol	Pin name	Value		Units	Remarks
			Min	Max		
Reset input time	t_{RSTL}	$\overline{RST}$	$4\ t_{CP}$	—	ns	Under normal operation
			Oscillation time of oscillator + $4\ t_{CP}$	—	ms	In stop mode
			100	—	μs	In pseudo timer mode (MB90543G (S) /547G (S) /548G (S))
			$4\ t_{CP}$	—	ns	In pseudo timer mode (Other than MB90543G (S) /547G (S) /548G (S))
			$2\ t_{LCP}$	—	μs	In sub-clock mode, sub-sleep mode, timer mode
Hardware standby input time	t_{HSTL}	HST	$4\ t_{CP}$	—	ns	Under normal operation

Note : " t_{cp} " represents one cycle time of the machine clock.

Oscillation time of oscillator is time that amplitude reached the 90%. In the crystal oscillator, the oscillation time is between several ms to tens of ms. In ceramic oscillator, the oscillation time is between hundreds of μs to several ms. In the external clock, the oscillation time is 0 ns.

Any reset can not fully initialize the Flash Memory if it is performing the automatic algorithm.

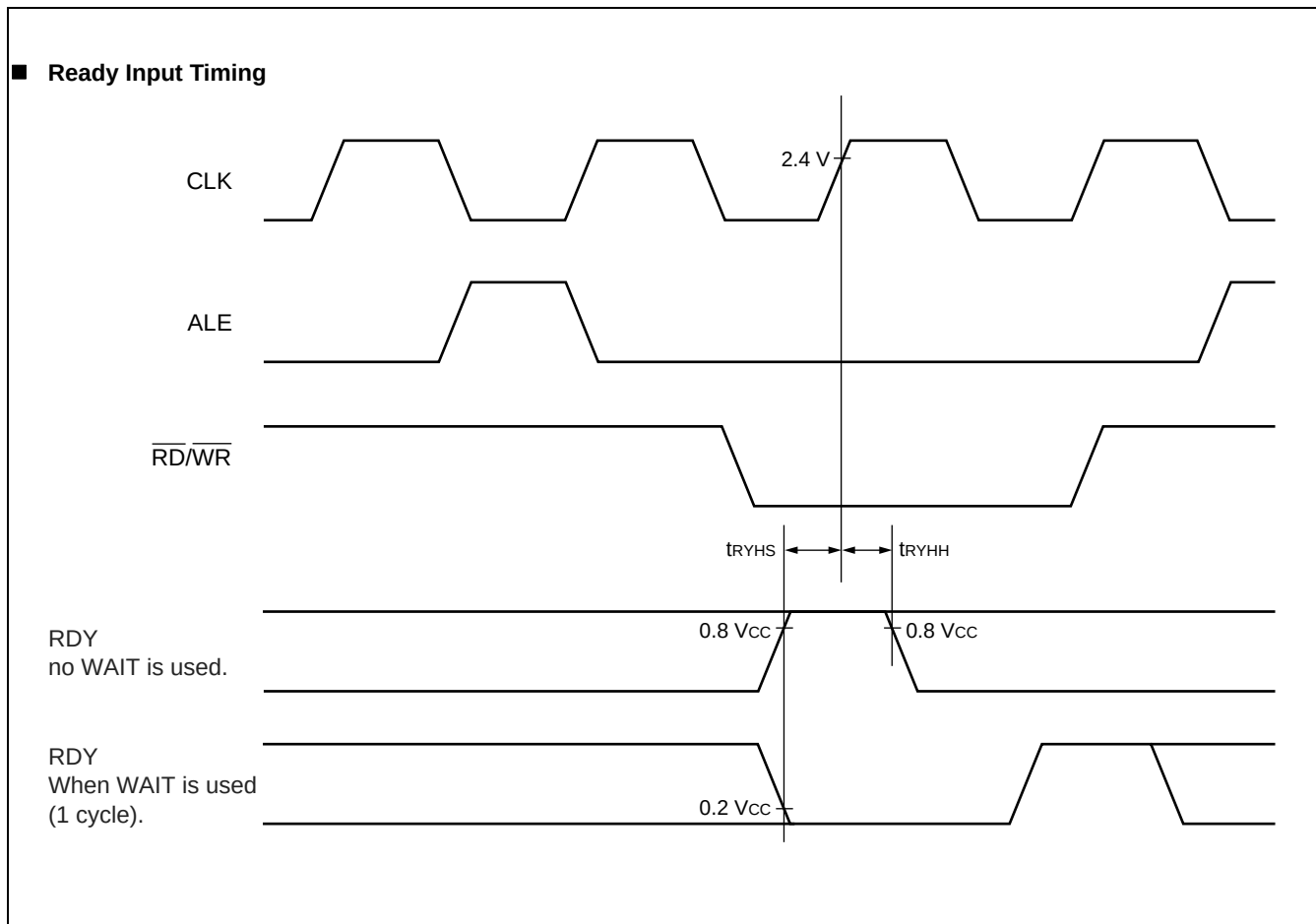
11.4.7 Ready Input Timing

(MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 3.5 \text{ V to } 5.5 \text{ V}$, $V_{SS} = AV_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^{\circ}\text{C to } +105 \text{ }^{\circ}\text{C}$)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^{\circ}\text{C to } +105 \text{ }^{\circ}\text{C}$)

Parameter	Symbol	Pin name	Condition	Value		Units	Remarks
				Min	Max		
RDY setup time	t_{RYHS}	RDY	—	45	—	ns	
RDY hold time	t_{RYHH}	RDY	—	0	—	ns	

Note : If the RDY setup time is insufficient, use the auto-ready function.



11.5 A/D Converter

11.5.1 Electrical Characteristics

($V_{CC} = AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0.0 \text{ V}$, $3.0 \text{ V} \leq AV_{RH} - AV_{RL}$, $T_A = -40 \text{ }^\circ\text{C}$ to $+105 \text{ }^\circ\text{C}$)

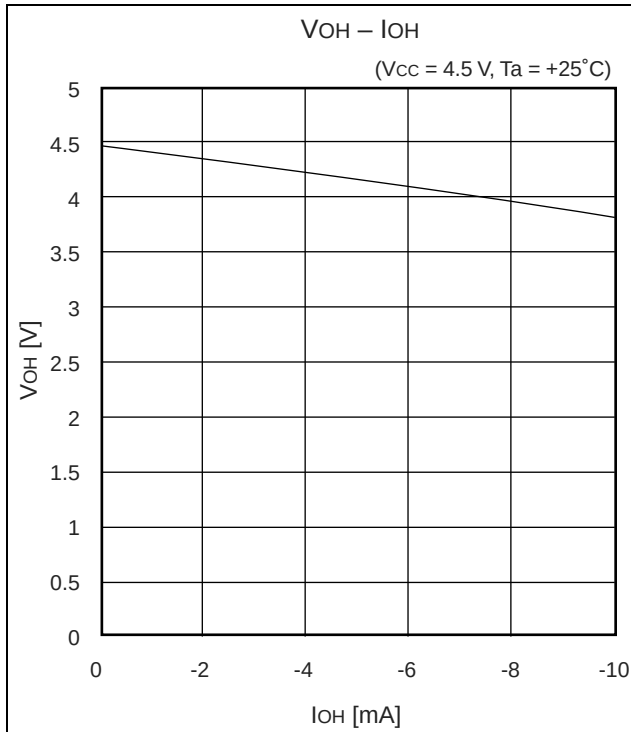
Parameter	Symbol	Pin name	Value			Units	Remarks
			Min	Typ	Max		
Resolution	—	—	—	—	10	bit	
Conversion error	—	—	—	—	± 5.0	LSB	
Nonlinearity error	—	—	—	—	± 2.5	LSB	
Differential nonlinearity error	—	—	—	—	± 1.9	LSB	
Zero transition voltage	V_{OT}	AN0 to AN7	$AV_{RL} - 3.5 \text{ LSB}$	$AV_{RL} + 0.5 \text{ LSB}$	$AV_{RL} + 4.5 \text{ LSB}$	V	
Full scale transition voltage	V_{FST}	AN0 to AN7	$AV_{RH} - 6.5 \text{ LSB}$	$AV_{RH} - 1.5 \text{ LSB}$	$AV_{RH} + 1.5 \text{ LSB}$	V	
Compare time	—	—	$352 t_{CP}$	—	—	ns	Internal frequency : 16 MHz
Sampling time	—	—	$64 t_{CP}$	—	—	ns	Internal frequency : 16 MHz
Analog port input current	I_{AIN}	AN0 to AN7	-1	—	1	μA	$V_{CC} = AV_{CC} = 5.0 \text{ V} \pm 1\%$
Analog input voltage range	V_{AIN}	AN0 to AN7	AV_{RL}	—	AV_{RH}	V	
Reference voltage range	—	AV_{RH}	$AV_{RL} + 2.7$	—	AV_{CC}	V	
	—	AV_{RL}	0	—	$AV_{RH} - 2.7$	V	
Power supply current	I_A	AV_{CC}	—	5	—	mA	
	I_{AH}	AV_{CC}	—	—	5	μA	*
Reference voltage supply current	I_R	AV_{RH}	—	400	600	μA	Flash device
			—	140	260	μA	MASK ROM
	I_{RH}	AV_{RH}	—	—	5	μA	*
Offset between input channels	—	AN0 to AN7	—	—	4	LSB	

* : When not using an A/D converter, this is the current ($V_{CC} = AV_{CC} = AV_{RH} = 5.0 \text{ V}$) when the CPU is stopped.

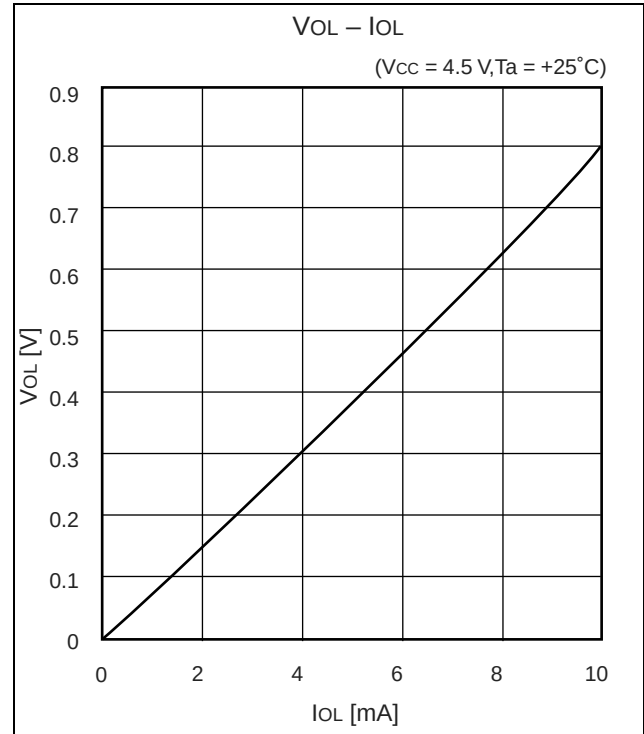
Note: The functionality of the A/D converter is only guaranteed for $V_{CC} = 5.0 \text{ V} \pm 10\%$ (also for MB90543G(S)/547G(S)/548G(S)/F548G(S)/F548GL(S)).

12. Example Characteristics

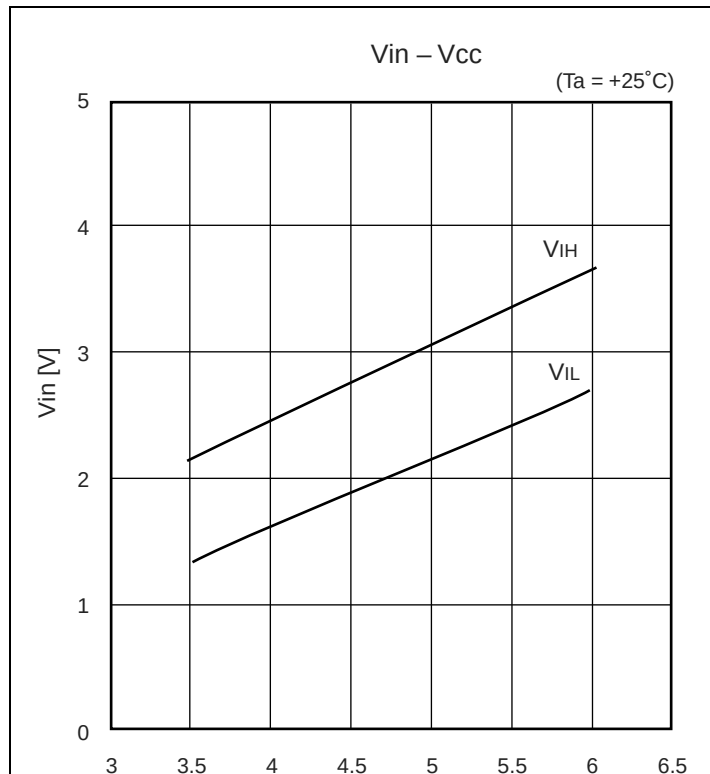
■ “H” level output voltage



■ “L” level output voltage



■ “H” level input voltage/ “L” level input voltage
(Hysteresis input)



■ Power supply current (MB90549G)

